FORM PTO-1595 (Modified)

RECORDATI:

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SEC.756

J.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

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To the Honorable Commissioner	Ratents an	d Trademarks:	Please record the attached origin	nal documents or copy thereof.
1. Name of conveying party(ies): JUN, Chung-sam HYUN, Pil-sik			Name and address of receiving party(ies): Name: SAMSUNG ELECTRONICS CO., LTD. Address: 406/ Pagtan-dong, Paldal-gu,	
Additional names(s) of conveying party(le	STEED IN	Yes 🛭 No	F 41 2 2 2	
3. Nature of conveyance:			25 200 E	
Assignment ■ Assignment	☐ Merge	er .	The make affect	
☐ Security Agreement	☐ Chang	ge of Name	City: Suwon-city, Kyungki-d	State/Prov.:
☒ Other DOCUMENT ID NO.	101514153		Country: Republic of Korea	ZIP:
Execution Date: September 20, 2000			Additional name(s) & address(es)	☐ Yes ☒ No
4. Application number(s) or registra		• •	, the execution date of the applic	ation is:
Patent Application No.	Filing date		B. Patent No.(s)	
09/685,094	October 11, 20	00		
	A	dditional numbers	☐ Yes 🏿 No	
5. Name and address of party to whom correspondence concerning document should be mailed:			6. Total number of applications and patents involved:	
Name: ADAM C. VOLENTINE			7. Total fee (37 CFR 3.41):\$	
Registration No. 33289			☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account	
Address: JONES VOLENTINE, LLC				
12200 SUNRISE VALLEY DRIV			Authorized to be charge	ed to deposit account
City: RESTON Country: U.S.A.	State/Prov	21	8. Deposit account number: 50-0238	
		DO NOT	USE THIS SPACE	
of the original document.	nd belief, the f	oregoing inform	ation is true and correct and any	.,
ADAM C. VOLENTINE			1V	JAN. 25, 2000
Name of Person Signing	_	of pages including	Signature cover sheet, attachments, and	5 Date

J O N E S VOLENTINE L.L.C. (6/2000)

ASSIGNMENT

No. of No.	In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned
lusert Name(s) of Inventor(s)	JUN, Chung-sam
	HYUN, Pil-sik
	the undersigned hereby sell(s) and assign(s) to
Insert Name(s)	SAMSUNG ELECTRONICS CO., LTD.
of Assignee(s) Address	of 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea
	(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as
	WAFER INSPECTION SYSTEM AND METHOD FOR SELECTIVELY INSPECTING CONDUCTIVE
Title of Invention	PATTERN DEFECTS
	for which an application for patent in the United States of America has been executed by the undersigned
Date of Signing of Application	on September 20,2000
er utherweven	The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
	The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
	The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
	The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
	The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or

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executed, and will not execute, any agreement in conflict herewith.

reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not

The undersigned hereby grant(s) to Raymond C. Jones, Reg. No. 34,631 and Adam C. Volentine, Reg. No. 33,289, of the firm of JONES VOLENTINE, L.L.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s). Date SEP. 20. 200 , Name of Inventor Chung-Sam JUN

Chung-Sam JUN

Chung-Sam JUN

Pil-sik HYUN Date ______, Name of Inventor _____ Date ______, Name of Inventor ______ Date _____, Name of Inventor _____ (Note regarding Witnessing and/or Acknowledgment: Acknowledgment before a United States Consul is preferred but not required. If not acknowledged, then it is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even if it has not been acknowledged and/or witnessed.) Witness _____ ACKNOWLEDGMENT This ______ day of ______, 19 , before me personally came the aboveto me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth. Official Signature SEAL Official Title Applicant Reference No.: SS-14352-US Atty Docket No.: SEC.756

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Serial No.: Filing Date:______

PATENT REEL: 011463 FRAME: 0777